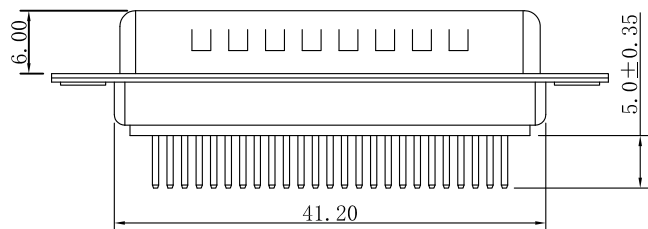
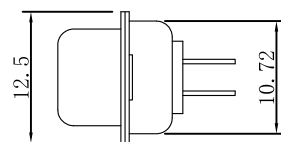
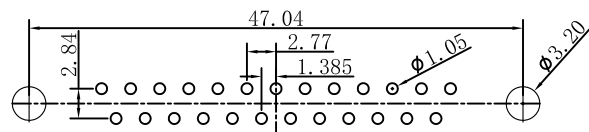


The product using material and processing must conform to the "WI-PZ-001" HSF technical standard control requirements



CHARACTERISTICS:

- 1、RATED VOLTAGE: 250V AC CD
- 2、RATED CURRENT: 3.0AMP
- 3、CONTACT RESISTANCE: 30mΩ Max.
- 4、INSULATION RESISTANCE: 1000 MΩ MIN. 500V DC
- 5、Electric Pressure: Keeping 60 second in AC 500V/1mA
- 6、Operating temperature: -55°C~105°C
- 7、INSERTION/EXTRACTION FORCE PER CONTACT: 8.5Kg Max
0.75Kg Min.



PCB layout

ORDER INFORMATION

Specification Type			
A	B	C	D
	6.00	4.80	5.80

P/N: WLDBM0-251XXX031

Number of Contact: _____

Contact Type: _____

1: DIP

Plating Contact: _____

1: Gold Flash
3: Au: 3U"
6: Au: 30U"

SCREW: _____

Housing color: _____

A: Black
S: Nature

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART. NO:	DWG. NO:	
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.03.11	WLDBM0-251XXX031	ENDE05	
			UNIT: mm	0.00±0.25	X° ±3°	DESIGNER	Ding_Bo	21.03.11	TITLE:		REV: A0 SHEET: 1/1
			SIZE: A4	0.000±0.10	X° X'±2°	DRAWN	Ou_Jian	21.03.11	DP 25M DIP		